To our customers,

Old Company Name in Catalogs and Other Documents

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Renesas Electronics website: http://www.renesas.com

April 1st, 2010
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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DATA SHEET

MOS FIELD EFFECT TRANSISTOR
μPA2734GR

SWITCHING
P-CHANNEL POWER MOS FET

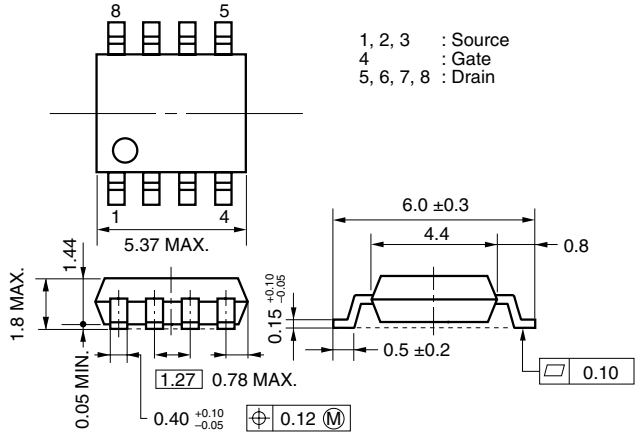
DESCRIPTION

The μPA2734GR is P-Channel MOS Field Effect Transistor designed for DC/DC converter and power management applications.

FEATURES

- Low on-state resistance
  $R_{DS(on)1}$ = 38 mΩ MAX. (V_{GS} = –4.5 V, I_D = –7.0 A)
  $R_{DS(on)2}$ = 72 mΩ MAX. (V_{GS} = –2.5 V, I_D = –3.5 A)
- Low input capacitance
  C_{iss} = 1130 pF TYP. (V_{DS} = –10 V, V_{GS} = 0 V)
- Built-in gate protection diode
- Small and surface mount package (Power SOP8)
- RoHS Compliant

PACKAGE DRAWING (Unit: mm)



ORDERING INFORMATION

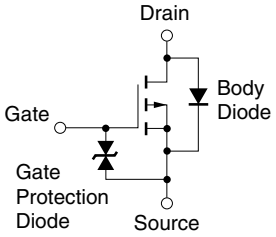
PART NUMBER	LEAD PLATING	PACKING	PACKAGE
μPA2734GR-E1-AT Note	Pure Sn	Tape 2500 p/reel	Power SOP8 0.08 g TYP.
μPA2734GR-E2-AT Note			

Note Pb-free (This product does not contain Pb in external electrode and other parts.)

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C, All terminals are connected.)

Drain to Source Voltage (V_{GS} = 0 V)	V_{DSS}	–30	V
Gate to Source Voltage (V_{DS} = 0 V)	V_{GSS}	∓12	V
Drain Current (DC) Note1	$I_{D(DC)}$	∓7	A
Drain Current (pulse) Note2	$I_{D(pulse)}$	∓28	A
Total Power Dissipation Note3	P_{T1}	1.1	W
Total Power Dissipation (PW = 10 sec) Note3	P_{T2}	2.5	W
Channel Temperature	T_{ch}	150	°C
Storage Temperature	T_{stg}	–55 to +150	°C

EQUIVALENT CIRCUIT



Notes 1. V_{GS} = –4.5 V
2. PW ≤ 10 μs, Duty Cycle ≤ 1%
3. Mounted on glass epoxy board of 25.4 mm x 25.4 mm x 0.8 mmt

Remark The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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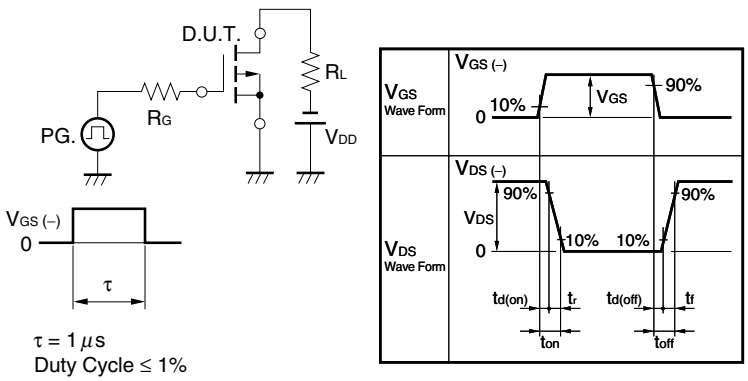
Date Published September 2008 NS
Printed in Japan

ELECTRICAL CHARACTERISTICS (T_A = 25°C, All terminals are connected.)

CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS} = –30 V, V_{GS} = 0 V			–1	μA
Gate Leakage Current	I_{GSS}	V_{GS} = ∓12 V, V_{DS} = 0 V			∓10	μA
Gate to Source Cut-off Voltage	$V_{GS(off)}$	V_{DS} = –10 V, I_D = –1 mA	–0.5		–1.5	V
Forward Transfer Admittance Note	$\|y_{fs}\|$	V_{DS} = –10 V, I_D = –3.5 A	5			S
Drain to Source On-state Resistance Note	$R_{DS(on)1}$	V_{GS} = –4.5 V, I_D = –7.0 A		32	38	mΩ
	$R_{DS(on)2}$	V_{GS} = –2.5 V, I_D = –3.5 A		53	72	mΩ
Input Capacitance	C_{iss}	V_{DS} = –10 V,		1130		pF
Output Capacitance	C_{oss}	V_{GS} = 0 V,		200		pF
Reverse Transfer Capacitance	C_{rss}	f = 1 MHz		160		pF
Turn-on Delay Time	$t_{d(on)}$	V_{DD} = –15 V, I_D = –3.5 A,		13		ns
Rise Time	t_r	V_{GS} = –4.5 V,		20		ns
Turn-off Delay Time	$t_{d(off)}$	R_G = 10 Ω		82		ns
Fall Time	t_f			77		ns
Total Gate Charge	Q_G	V_{DD} = –24 V,		12		nC
Gate to Source Charge	Q_{GS}	V_{GS} = –4.5 V,		2.7		nC
Gate to Drain Charge	Q_{GD}	I_D = –7 A		5.9		nC
Body Diode Forward Voltage Note	$V_{F(S-D)}$	I_F = 7 A, V_{GS} = 0 V		0.93	1.2	V
Reverse Recovery Time	t_{rr}	I_F = 7 A, V_{GS} = 0 V,		64		ns
Reverse Recovery Charge	Q_{rr}	di/dt = 100 A/μs		55		nC

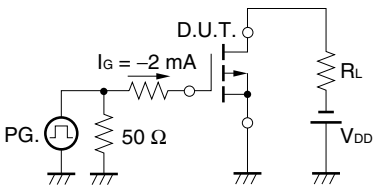
Note Pulsed

TEST CIRCUIT 1 SWITCHING TIME



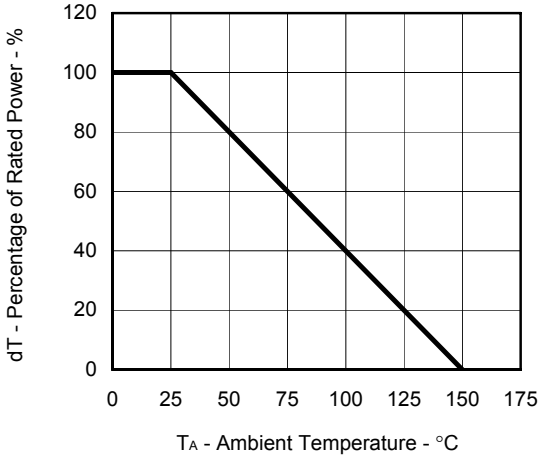
τ = 1 μs
Duty Cycle ≤ 1%

TEST CIRCUIT 2 GATE CHARGE

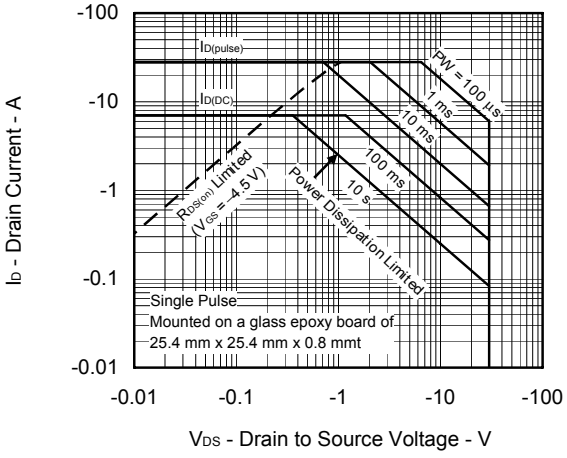


ELECTRICAL CHARACTERISTICS (T_A = 25°C)

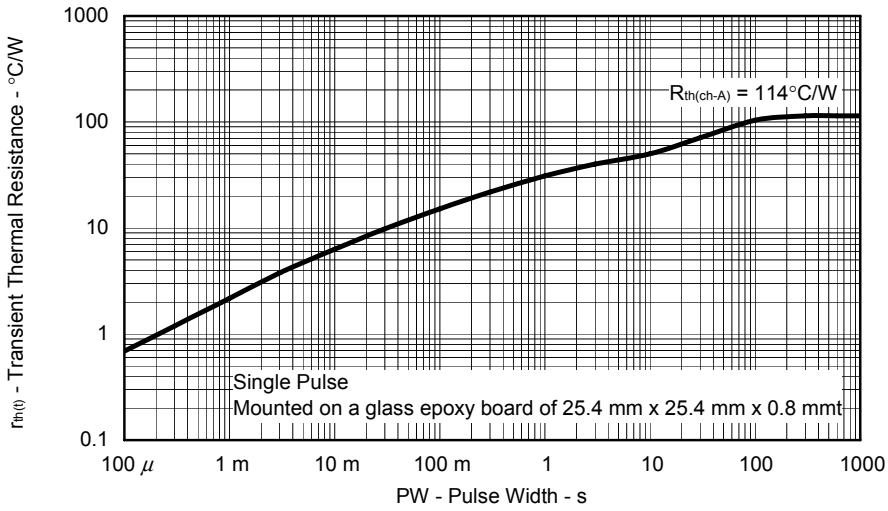
DERATING FACTOR OF FORWARD BIAS SAFE OPERATING AREA



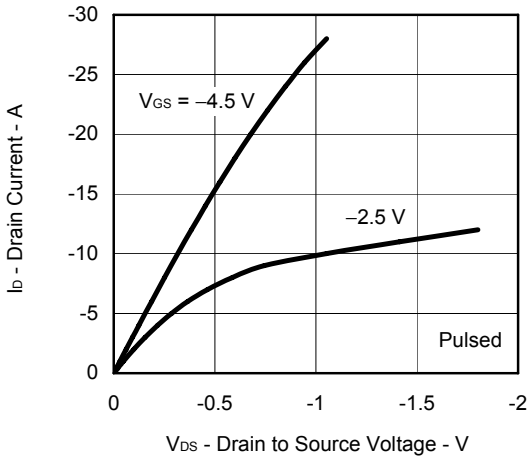
FORWARD BIAS SAFE OPERATING AREA



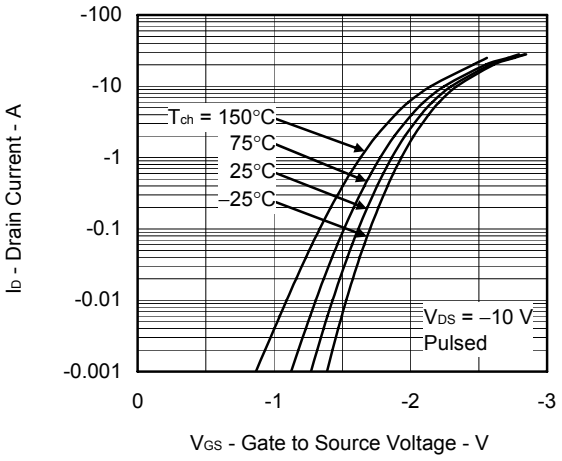
TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



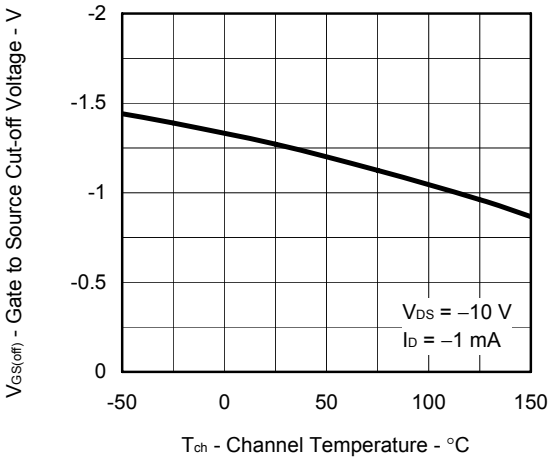
DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE



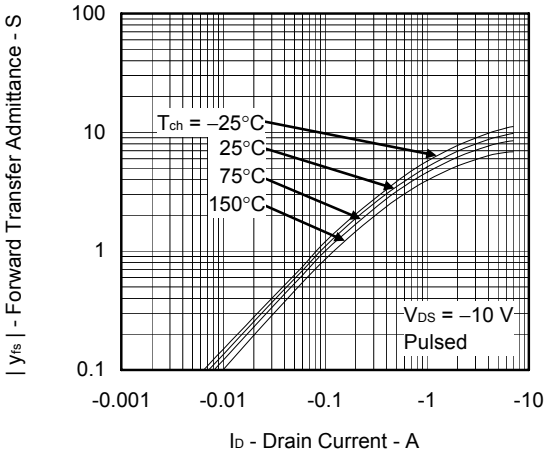
FORWARD TRANSFER CHARACTERISTICS



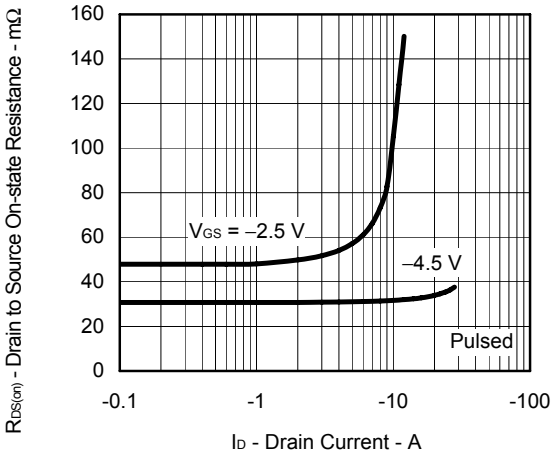
GATE TO SOURCE CUT-OFF VOLTAGE vs. CHANNEL TEMPERATURE



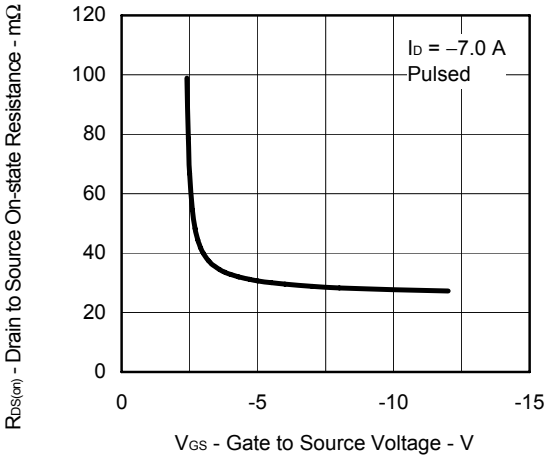
FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



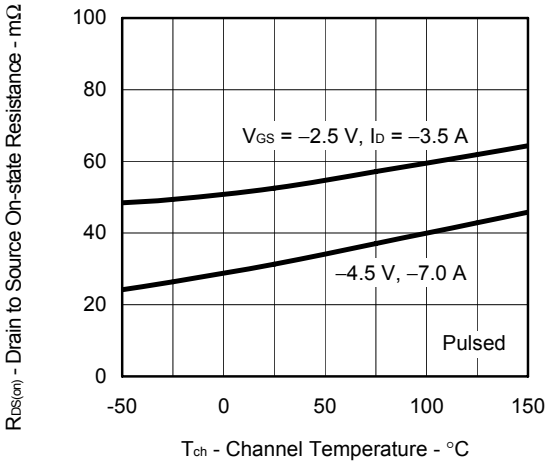
DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



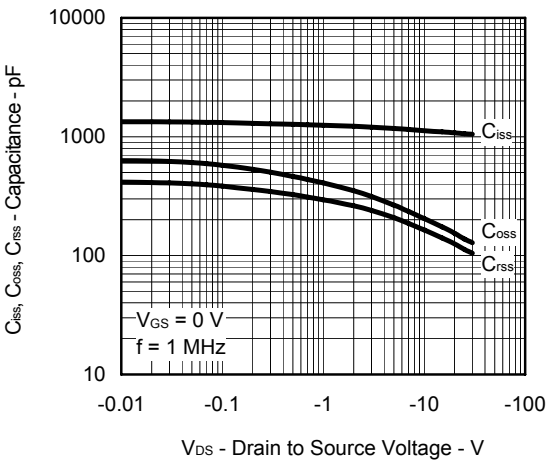
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE



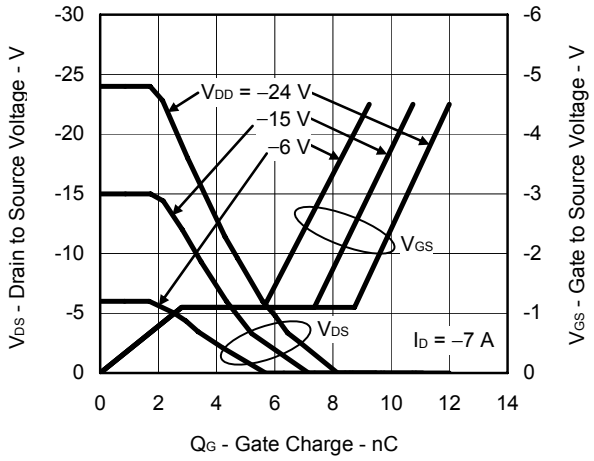
DRAIN TO SOURCE ON-STATE RESISTANCE vs. CHANNEL TEMPERATURE



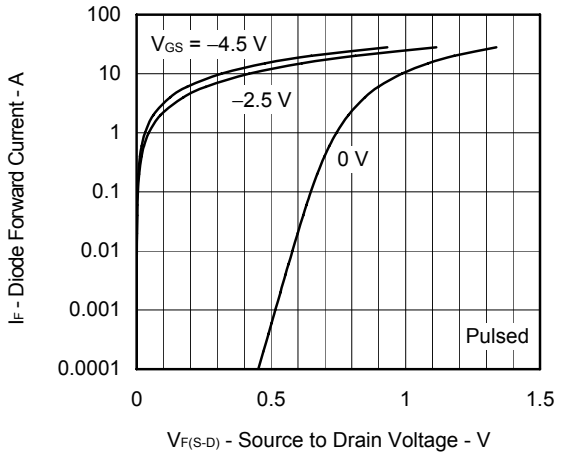
CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE



DYNAMIC INPUT/OUTPUT CHARACTERISTICS



SOURCE TO DRAIN DIODE FORWARD VOLTAGE



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